

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

FUNAMOTO et al.

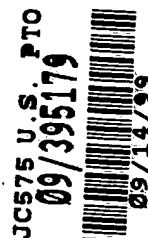
Serial No.: New Application

Group Art Unit:

Filed: September 14, 1999

Examiner:

For: PACKAGE FOR ELECTRONIC COMPONENT, LID MATERIAL FOR
PACKAGE LID, AND PRODUCTION METHOD FOR LID MATERIAL



INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

September 14, 1999

Sir:

In compliance with applicants' duty of disclosure under 37 CFR 1.56,
enclosed are copies of material information of which applicants are aware, and which may
be relevant to the above-identified application.

In the event that any fees are due with this paper, please charge our Deposit
Account No. 14-1060.

Respectfully submitted,

NIKAIDO, MARMELESTEIN, MURRAY & ORAM LLP

A handwritten signature in cursive script that reads "George E. Oram, Jr.".

George E. Oram, Jr.
Attorney for Applicants
Reg. No. 27,931

Atty. Docket No.: P7459-9002
Metropolitan Square
655 15th Street, N. W.
Suite 330 - G Street Lobby
Washington, D. C. 20005-5701
Tel (202) 638-5000
Fax (202) 638-4810
GEO/hk
Enclosures: PTO-1449, References (4)